



BAT54TW /ADW / CDW /SDW /BRW

Dim

Α

В

С

D

F

Н

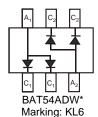
SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAYS

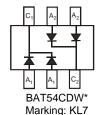
Features

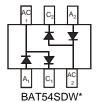
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please See Ordering Information, Note 6, on Page 3
- Orientation: See Diagrams Below
- Marking Information: See Diagrams Below & Page 3
- Weight: 0.006 grams (approximate)

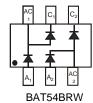




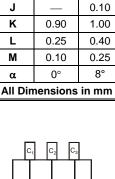


Marking: KL8

TOP VIEW



Marking: KLB



SOT-363

Min

0.10

1.15

2.00

0.30

1.80

Max

0.30

1.35

2.20

0.40

2.20

0.65 Nominal



Marking: KLA

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	30	V		
Forward Continuous Current	(Note 1)	I _F	200	mA		
Repetitive Peak Forward Current	(Note 1)	I _{FRM}	300	mA		
Forward Surge Current (Not	e 1) @ t < 1.0s	I _{FSM}	600	mA		
Power Dissipation	(Note 1)	P _d	200	mW		
Thermal Resistance, Junction to Ambient Air	$R_{ heta JA}$	625	°C/W			
Operating and Storage Temperature Range	Tj, T _{STG}	-65 to +125	°C			

Notes:

- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

^{*}Symmetrical configuration, no orientation indicator.



Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic			Min	Тур	Max	Unit	Test Condition		
Reverse Breakdown Voltage	(Note 5)	$V_{(BR)R}$	30	_	_	V	$I_R = 100 \mu A$		
Forward Voltage	(Note 5)	VF	_	_	240 320 400 500 1000	mV	I _F = 0.1mA I _F = 1mA I _F = 10mA I _F = 30mA I _F = 100mA		
Reverse Leakage Current	(Note 5)	I _R	_	_	2.0	μΑ	V _R = 25V		
Total Capacitance		C _T	_	_	10	pF	V _R = 1.0V, f = 1.0MHz		
Reverse Recovery Time		t _{rr}	_	_	5.0	ns	I_F = 10mA through I_R = 10mA to I_R = 1.0mA, R_L = 100 Ω		

Notes: 5. Short duration pulse test used to minimize self-heating effect.

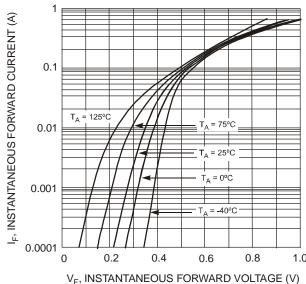
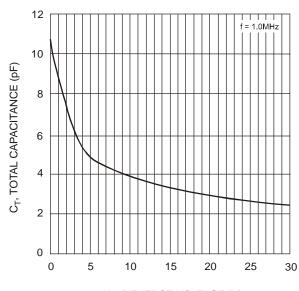
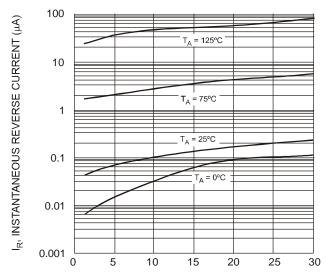


Fig. 1 Forward Characteristics



 $\label{eq:VR} {\rm V_R,\,REVERSE\,\,VOLTAGE\,(V)}$ Fig. 3 Typical Capacitance vs. Reverse Voltage



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics

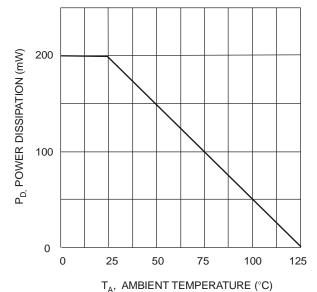


Fig. 4 Power Derating Curve

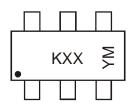


Ordering Information (Note 6)

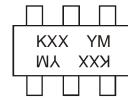
Device	Packaging	Shipping
BAT54ADW-7	SOT-363	3000/Tape & Reel
BAT54CDW-7	SOT-363	3000/Tape & Reel
BAT54SDW-7	SOT-363	3000/Tape & Reel
BAT54BRW-7	SOT-363	3000/Tape & Reel
BAT54TW-7	SOT-363	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



KXX = Product Type Marking Code (See Page 1) YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September



KXX = Product Type Marking Code (See Page 1) For Symmetrical Configuration, No Orientation Indicator YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	a	0	N	D

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.